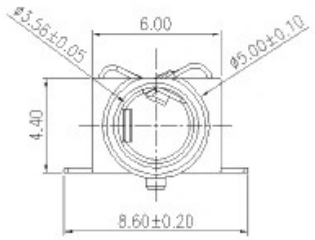
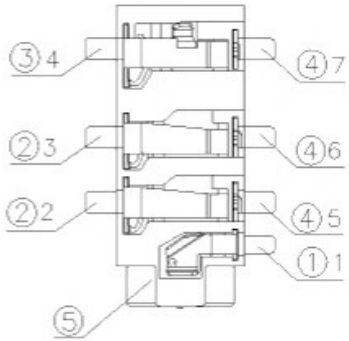
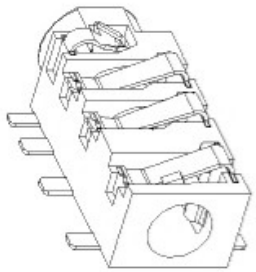
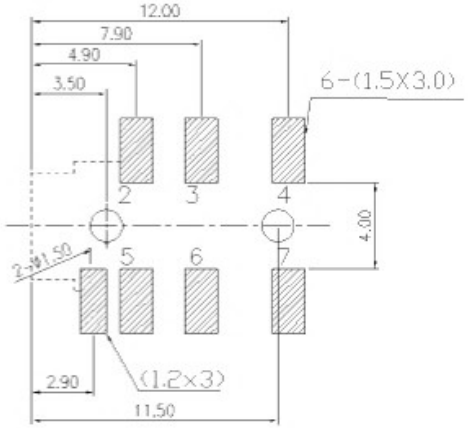
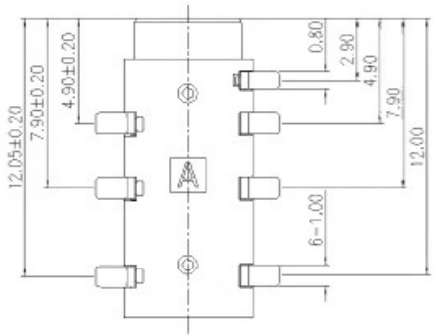


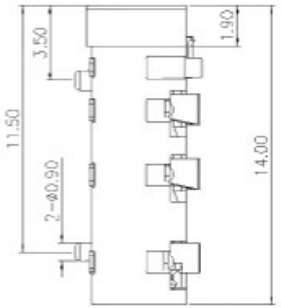


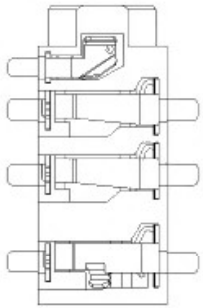




PCB LAYOUT TOP VIEW

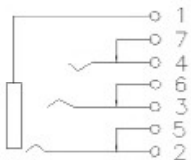




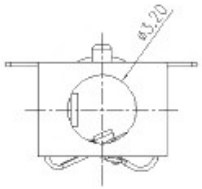


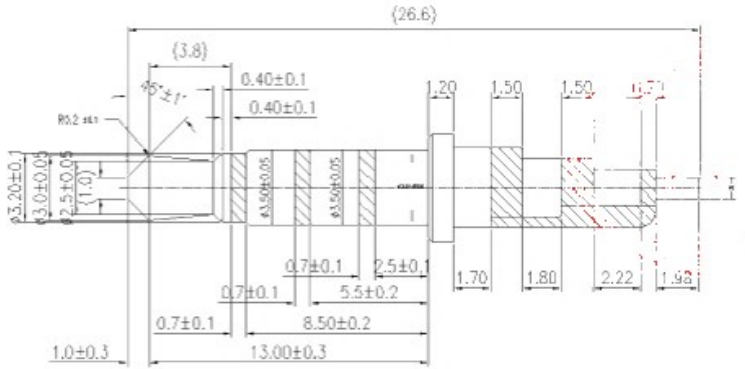
SPECIFICATIONS:

1. ELECTRICAL CHARACTERISTICS:
   1-1. RATING:
   1-2. CONTACT RESISTANCE: 30mΩ MAX.(INITIAL)
   1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE
   1-4. INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 50DV DC
2. MECHANICAL CHARACTERISTICS:
   2-1. INSERTION FORCE : 0.3~3.0 KGF
   2-2. WITHDRAWAL FORCE : 0.3~3.0 KGF
3. LIFE TEST: 5,000 CYCLES MIN.
4. FOR REFLOW SOLDERING LEAD-FREE PROCESS.
5. * REPRESENT CRITICAL DIMENSIONS.



CIRCUIT DIAGRAM





	MATERIAL	PLATING
terminal 1	Phosphor Bronze	Gold
terminal 2	Phosphor Bronze	Gold
terminal 3	Phosphor Bronze	Gold
terminal 4	Phosphor Bronze	Gold
terminal 5	Phosphor Bronze	Gold
terminal 6	Phosphor Bronze	Gold
terminal 7	Phosphor Bronze	Gold
plastic	High Temp. Thermoplastic	

MARK	DESCRIPTION	DATE	REVISED	APPROVED
△x				
△x				
△x				

REVISIONS

ANGLAR	±5°
X.X	±0.2mm
X.XX	±0.1mm
X.XXX	±0.05mm

UNSPECIFIED TOLERANCES

DSND		DATE		SCALE: N/A	MODEL TYPE: 3.5 PHONE JACK
DWN		DATE		VIEW:	PART NO.:
CHKD		DATE		UNIT: mm	DWG NO.:
APPD		DATE		SIZE: A4	

东莞市溪榜电子有限公司

WEIGHT	SHEET	REVISION
1.0g	1/1	A0